

FDMC7680 N-Channel Power Trench[®] MOSFET **30 V, 14.8 A, 7.2 m**Ω

Features

- Max r_{DS(on)} = 7.2 mΩ at V_{GS} = 10 V, I_D = 14.8 A
- Max r_{DS(on)} = 9.5 mΩ at V_{GS} = 4.5 V, I_D = 12.4 A
- High performance technology for extremely low r_{DS(on)}
- Termination is Lead-free and RoHS Compliant

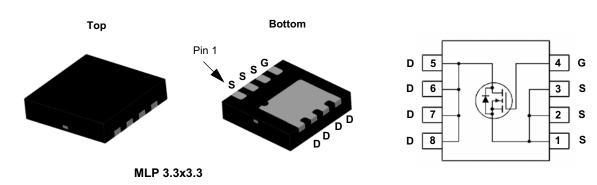


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

Application

- DC DC Buck Converters
- Notebook battery power management
- Load switch in Notebook



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DS}	Drain to Source Voltage			30	V
V _{GS}	Gate to Source Voltage			±20	V
	Drain Current -Continuous (Package limited)	T _C = 25 °C		18	
I _D	-Continuous	T _A = 25 °C	(Note 1a)	14.8	Α
	-Pulsed			45	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	72	mJ
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.3	W
T _J , T _{STG}	Operating and Storage Junction Temperature R	ange		-55 to +150	°C
Thermal Cl	haracteristics				
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient		(Note 1a)	53	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC7680	FDMC7680	MLP 3.3x3.3	13 "	12 mm	3000 units

FDMC7680 Rev.B

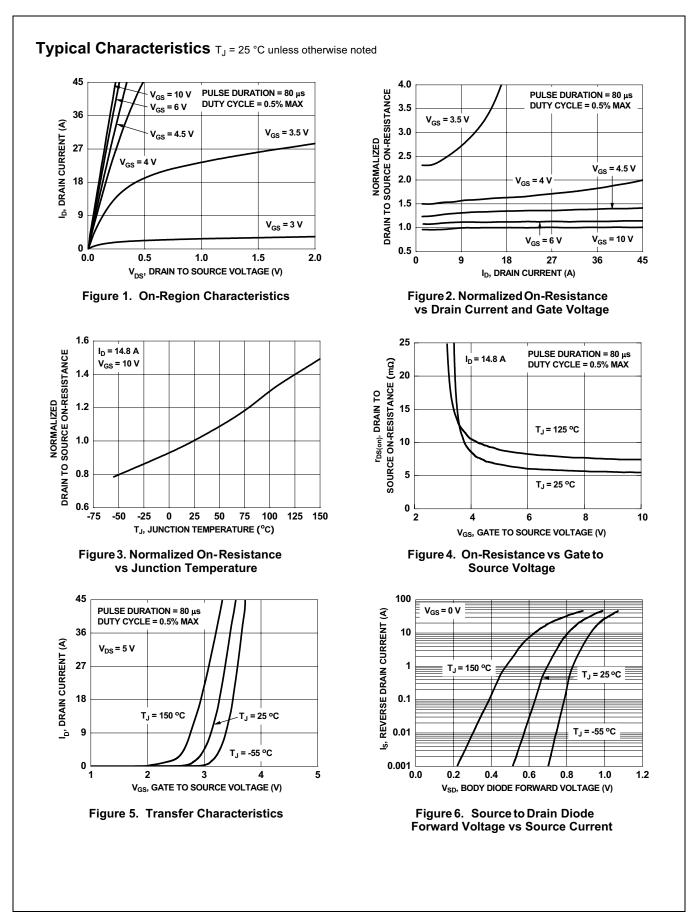
July 2009

$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$ I_{DSS} I_{GSS}	Drain to Source Breakdown Voltage			Тур		Units
∆BV _{DSS} ∆T _J I _{DSS} I _{GSS}	Drain to Source Breakdown Voltage					
ΔBV _{DSS} ΔT _J I _{DSS} I _{GSS}		I _D = 250 μA, V _{GS} = 0 V	30			V
ΔT _J I _{DSS} I _{GSS}	Breakdown Voltage Temperature			45		
I _{GSS}	Coefficient	I_D = 250 $\mu A,$ referenced to 25 °C		15		mV/°C
I _{GSS}	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V			1	μA
	Zero Gale Voltage Drain Current	$T_{\rm J} = 125 ^{\circ}{\rm C}$ V _{GS} = 20 V, V _{DS} = 0 V			250	μΛ
	Gate to Source Leakage Current	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
un (Thara	cteristics					
			1.0	2.0	2.0	V
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$	1.2	2.0	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		-6		mV/°C
4.1		V _{GS} = 10 V, I _D = 14.8 A		5.8	7.2	
		$V_{GS} = 4.5 \text{ V}, I_D = 12.4 \text{ A}$		7.3	9.5	-
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 14.8 \text{ A}$				mΩ
		$T_{\rm J}$ = 125 °C		7.4	9.2	
9 _{FS}	Forward Transconductance	V _{DD} = 5 V, I _D = 14.8 A		68		S
Dunamia	Characteristics					
-						-
C _{iss}	Input Capacitance	V _{DS} = 15 V, V _{GS} = 0 V,		2145	2855	pF
C _{oss}	Output Capacitance	f = 1 MHz		770	1020	pF
~	Reverse Transfer Capacitance			75	115	pF
						0
	Gate Resistance			0.5		Ω
R _g				0.5		Ω
R _g Switching	g Characteristics				22	I
R _g Switching t _{d(on)}	g Characteristics Turn-On Delay Time			12	22	ns
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 15 \text{ V}, \text{ I}_{D} = 14.8 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		12 4	10	ns ns
R _g Switching t _{d(on)} t _r	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	V _{DD} = 15 V, I _D = 14.8 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		12 4 25	10 40	ns ns ns
R _g Switching t _{d(on)} t _r t _{d(off)} t _f	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	V _{GS} = 10 V, R _{GEN} = 6 Ω		12 4 25 3	10	ns ns ns ns
R _g Switching t _{d(on)} t _r t _{d(off)} t _f	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	V_{GS} = 10 V, R_{GEN} = 6 Ω V _{GS} = 0 V to 10 V		12 4 25 3 30	10 40 10	ns ns ns nc
R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)}	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	V_{GS} = 10 V, R_{GEN} = 6 Ω V _{GS} = 0 V to 10 V		12 4 25 3 30 14	10 40 10 42	ns ns ns nC nC
R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)} Q _{gs}	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge	V _{GS} = 10 V, R _{GEN} = 6 Ω		12 4 25 3 30	10 40 10 42	ns ns ns nc
R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)} Q _{gs} Q _{gd}	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge	V_{GS} = 10 V, R_{GEN} = 6 Ω V _{GS} = 0 V to 10 V		12 4 25 3 30 14 7	10 40 10 42	ns ns ns nC nC
R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)} Q _{gs} Q _{gd}	y Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $I_D = 15 \text{ V}$ $I_D = 14.8 \text{ A}$		12 4 25 3 30 14 7	10 40 10 42	ns ns ns nC nC
R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)} Q _{gs} Q _{gd} Drain-Sou	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $I_D = 15 \text{ V}$ $I_D = 14.8 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 14.8 \text{ A}$ (Note 2)		12 4 25 3 30 14 7 4	10 40 10 42 19 1.2	ns ns ns nC nC
R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)} Q _{gs} Q _{gd}	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics Source to Drain Diode Forward Voltage	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $I_D = 15 \text{ V}$ $I_D = 14.8 \text{ A}$		12 4 25 3 30 14 7 4 0.84 0.73	10 40 10 42 19 1.2 1.2	ns ns ns nC nC nC
R _g Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)} Q _{gs} Q _{gd} Drain-Sou	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Total Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $I_D = 15 \text{ V}$ $I_D = 14.8 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 14.8 \text{ A}$ (Note 2)		12 4 25 3 30 14 7 4	10 40 10 42 19 1.2	ns ns ns nC nC nC

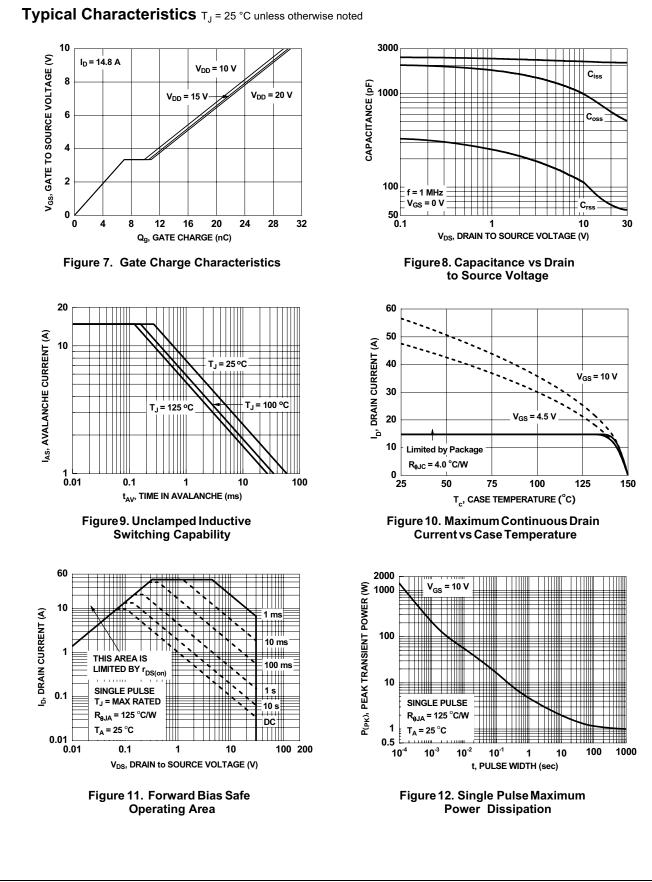
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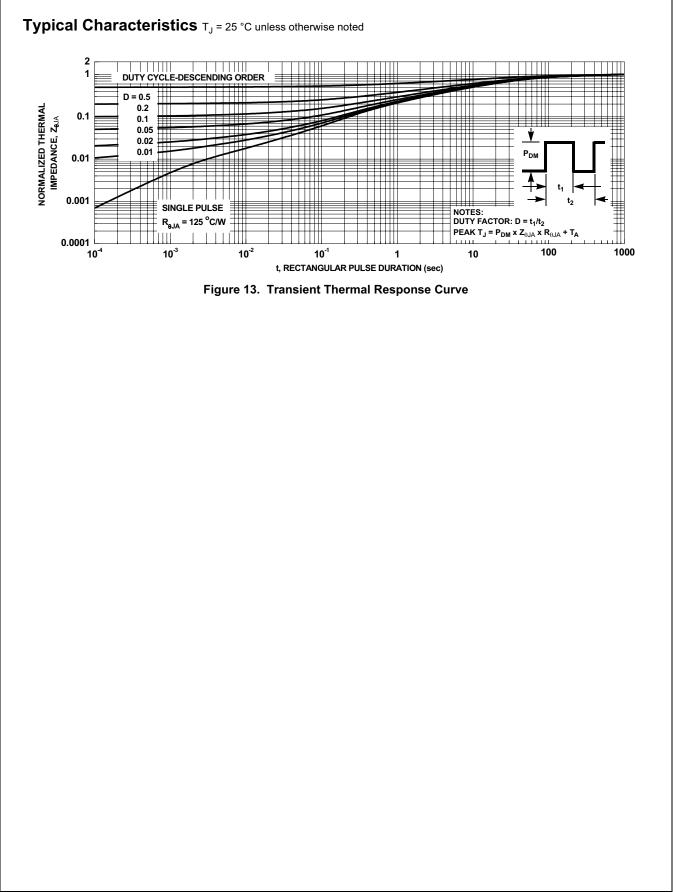
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0 %. 3. E_{AS} of 72 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 12 A, V_{DD} = 27 V, V_{GS} = 10 V. 100% test at L = 3 mH, I_{AS} = 5.7 A.



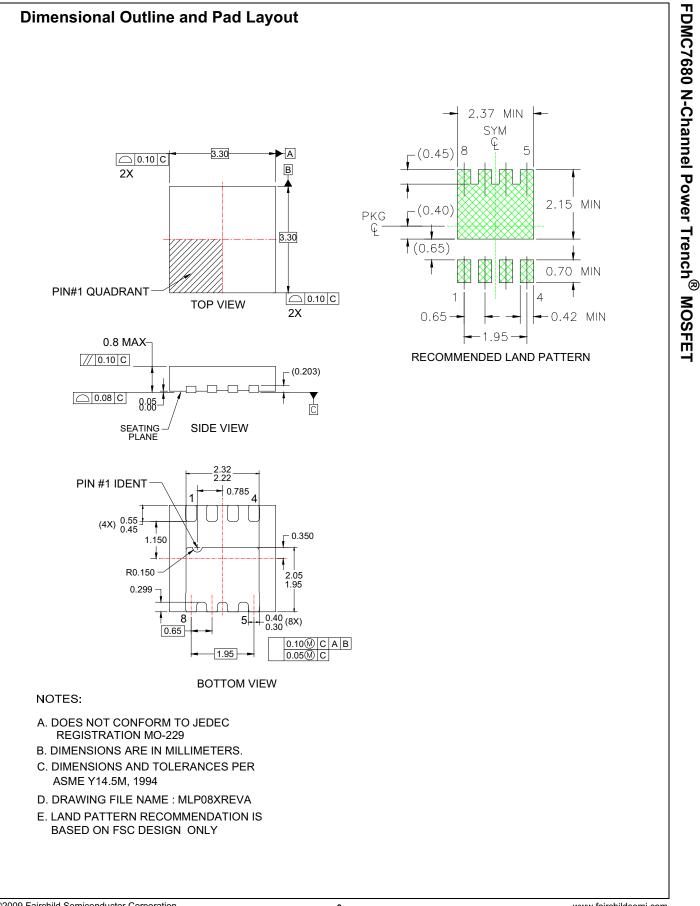




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FDMC7680 N-Channel Power Trench[®] MOSFET





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